100A 650V Trench Fieldstop IGBT with anti-parallel diode SRE100N065FSUD8

General Description

The SRE100N065FSUD8 is a Field Stop Trench IGBT with anti-parallel diode, which offers ultra-low switching losses, high energy efficiency for switching applications such as PFC, Power Supply, Inverter, etc.

The SRE100N065FSUD8 package is TO-247.

Features

- High Breakdown Voltage to 650V
- Advanced Trench Fieldstop technology
  - Ultra low E_{off}
  - High Ruggedness, Temperature Stability
  - Easy Parallel Switching Capability due to Positive Temperature Coefficient in $V_{CE(SAT)}$
- Low $V_{CE(SAT)}$
- Enhanced Avalanche Capability

Application

- Inverter
- Uninterruptible power supplies
- PFC application
- Converter with high switching frequency

Symbol

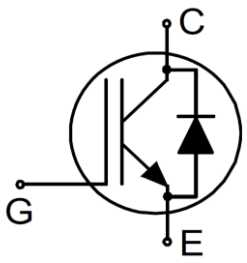
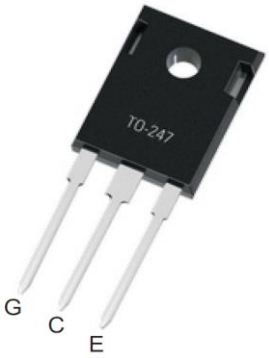


Figure 1 Symbol of SRE100N065FSUD8

Package Type



TO-247

Figure 2 Package Type of SRE100N065FSUD8

Ordering Information

SRE100N065FSUD8□□–□

Circuit Type

Package
T: TO-247

E: Lead Free
G: Green

Blank: Tube
TR: Tape & Reel

Package	Part Number	Marking ID	Packing Type
	Green	Green	
TO-247	SRE100N065FSUD8T-G	SRE100N065FSUD8TG	Tube

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Absolute Maximum Ratings

Parameter		Symbol	Rating	Unit
Collector-emitter Voltage		V_{CES}	650	V
Gate-emitter Voltage		V_{GES}	±20	V
Transient Gate-emitter Voltage ($t_p \leq 10\mu s$)			±30	V
Continuous Collector Current	T_C=25℃	I_C	125	A
	T_C=100℃		100	
Pulsed Collector Current,Limited by T_{Jmax}		I_{CM}	400	A
Diode Continuous Collector Current	T_C=25℃	I_F	100	A
	T_C=100℃		80	
Diode Pulsed Current, Limited by T_{Jmax}		I_{FM}	320	A
Power Dissipation	T_C=25℃	P_{tot}	328	W
	T_C=100℃		131	
Operating Junction Temperature Range		T_J	-40 ~ 150	℃
Storage Temperature Range		T_{STG}	-55 ~ 150	℃
Lead Temperature (Soldering, 10 sec)		T_{LEAD}	260	℃

Thermal Resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
IGBT Thermal Resistance，Junction-to-Case	R_{thJC}	-	-	0.38	℃/W
Diode Thermal Resistance，Junction-to-Case	R_{thJC}	-	-	0.45	
Thermal Resistance，Junction-to-Ambient	R_{thJA}	-	-	40	

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Electrical Characteristics

T_J = 25 ℃, unless otherwise specified.

Parameter		Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Statistic Characteristics							
Collector-emitter Breakdown Voltage		BV_{CES}	V_{GE}=0V, I_C=250μA	650			V
Gate Threshold Voltage		$V_{GE(th)}$	V_{CE}=V_{GE}, I_C=250μA	4.0	4.8	6.0	V
Collector-emitter saturation voltage		V_{CEsat}	V_{GE}=15V, I_C=100A, T_J=25 ℃		1.46	2.0	V
			T_J=125 ℃		1.68		V
			T_J=150 ℃		1.75		V
Zero Gate Voltage Collector Current		I_{CES}	V_{CE}=650V,V_{GE}=0V T_J=25 ℃		0.1	40	μA
			T_J=150 ℃			1	mA
Gate-emitter Leakage Current	Forward	I_{GESF}	V_{GE}=20V, V_{CE}=0V			100	nA
	Reverse	I_{GESR}	V_{GE}=-20V, V_{CE}=0V			-100	nA
Dynamic Characteristics							
Input Capacitance		C_{IES}	V_{CE}=25V, V_{GE}=0V, f=1 MHz		3750		pF
Output Capacitance		C_{OES}			350		
Reverse Transfer Capacitance		C_{RES}			40		
Gate Resistance		R_G	f=1 MHz, Open Drain		1.7		Ω
Turn-on Delay Time		$t_{d(on)}$	T_J=25 ℃ V_{CC}=400V, I_C=100A R_G=15Ω, V_{GE}=0/15V		50		ns
Rise Time		t_r			110		ns
Turn-off Delay Time		$t_{d(off)}$			300		ns
Fall Time		t_f			68		ns
Turn-on energy		E_{on}			5.85		mJ
Turn-off energy		E_{off}			1.55		mJ
Total switching energy		E_{ts}			7.4		mJ
Turn-on Delay Time		$t_{d(on)}$	T_J=150 ℃ V_{CC}=400V, I_C=100A R_G=15Ω,V_{GE}=0/15V		45		ns
Rise Time		t_r			120		ns
Turn-off Delay Time		$t_{d(off)}$			395		ns
Fall Time		t_f			83		ns
Turn-on energy		E_{on}			7.85		mJ
Turn-off energy		E_{off}			2.55		mJ
Total switching energy		E_{ts}			10.4		mJ
Gate to Emitter Charge		Q_{GE}	V_{CC}=400V, I_C=100A V_{GE}=0 to 15V		65		nC
Gate to Collector Charge		Q_{GC}			89		
Gate Charge Total		Q_G			215		

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Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Reverse Diode Characteristics						
Drain-Source Diode Forward Voltage	V_F	V_{GE}=0V, I_F=80A T_J=25℃		1.67	2.0	V
		T_J=125℃		1.50		
		T_J=150℃		1.43		
Reverse Recovery Time	t_{rr}	T_J=25℃ V_R=400V, I_F=100A dI$_F$/dt=700A/μs		125		ns
Reverse Recovery Charge	Q_{rr}			1084		nC
Peak Reverse Recovery Current	I_{rrm}			18.5		A

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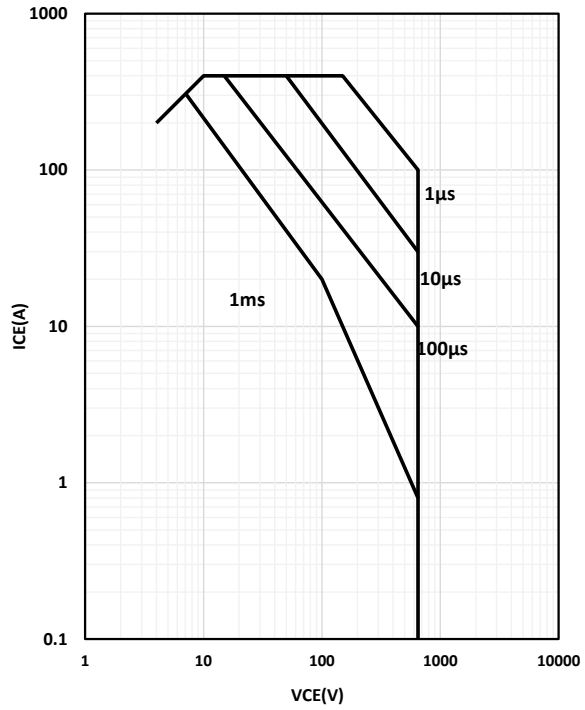
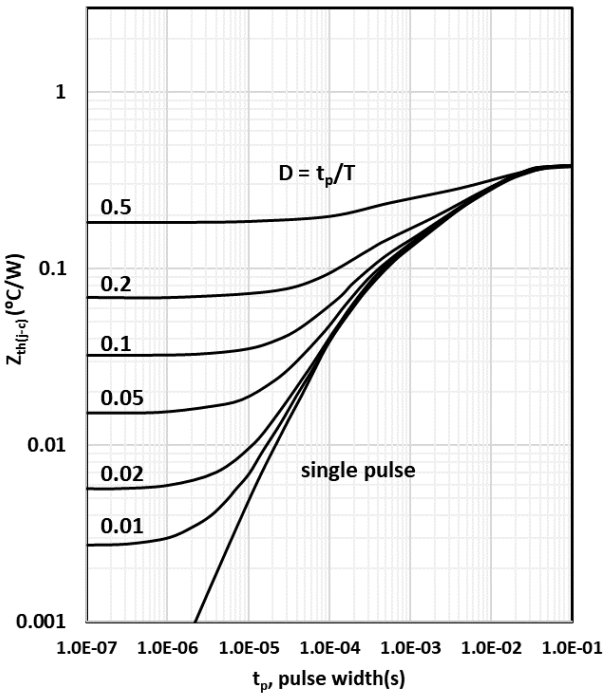
Typical Performance Characteristics

Figure 3: IGBT FBSOA



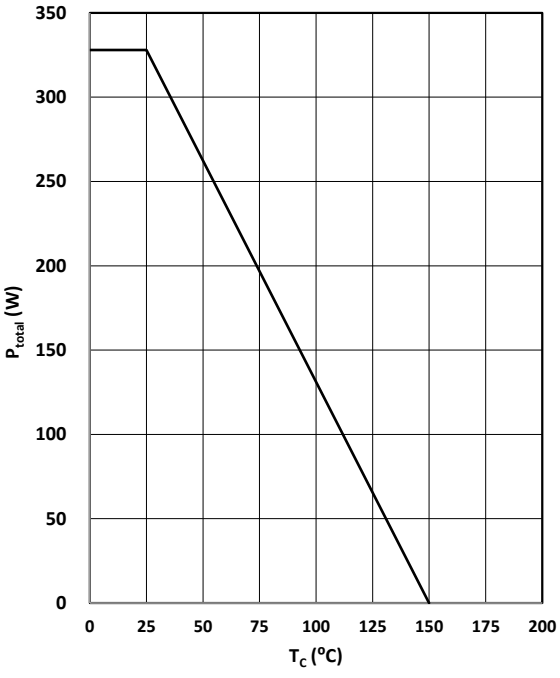
$I_C = f(V_{CE})$; $V_{GE} \geq 15/0V$; Tj≤ 150 ℃

Figure 4: IGBT transient thermal impedance



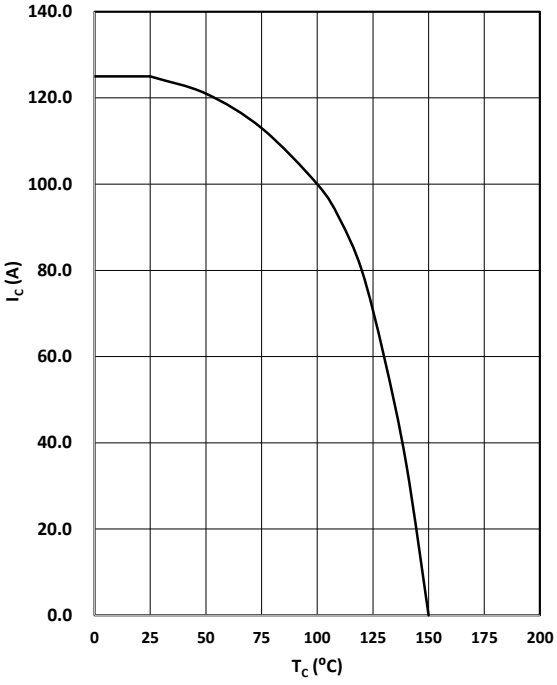
$R_{th(J-C)}$= f(t_p); duty cycle: D= t_p/T

Figure 5: Power dissipation



Ptot= f(Tc);

Figure 6: Collector current vs. temperature



Ic= f(Tc); $V_{GE} \geq 15V$; Tj≤150 ℃

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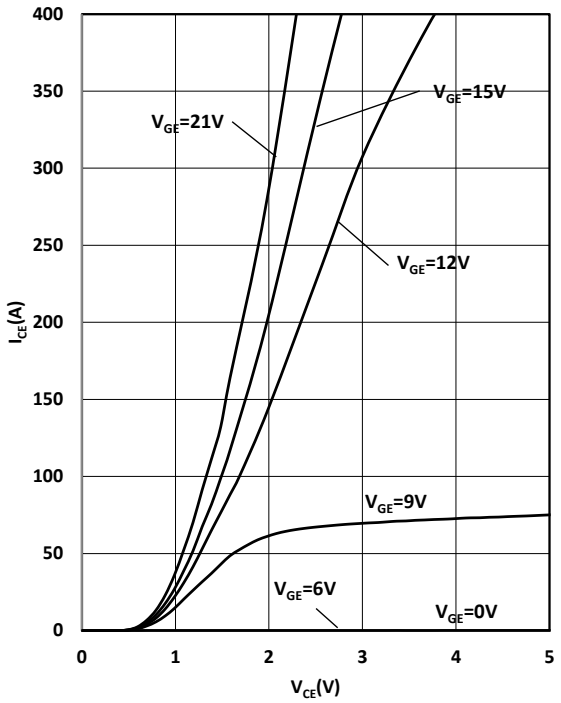
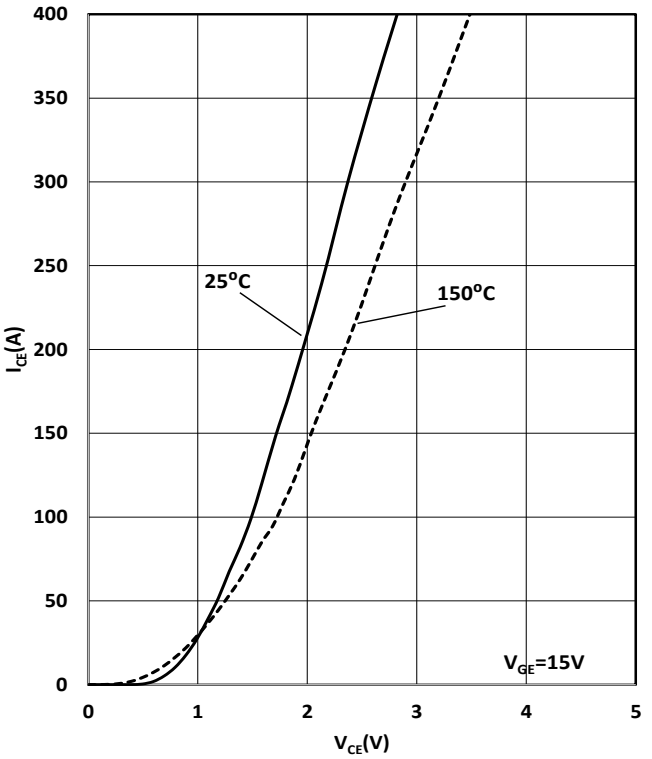
Figure 7: Typ. Output Characteristics



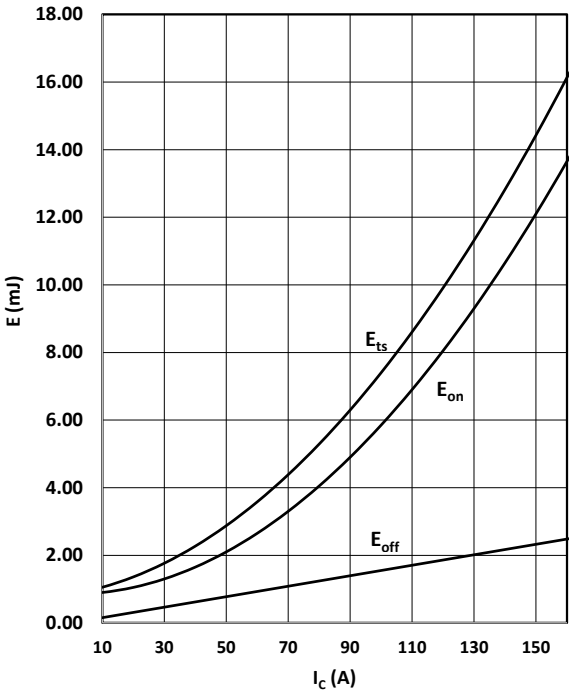
$I_C = f(V_{CE})$; Tj= 25 ℃; parameter: V_{GE}

Figure 8: Saturation Voltage Characteristics



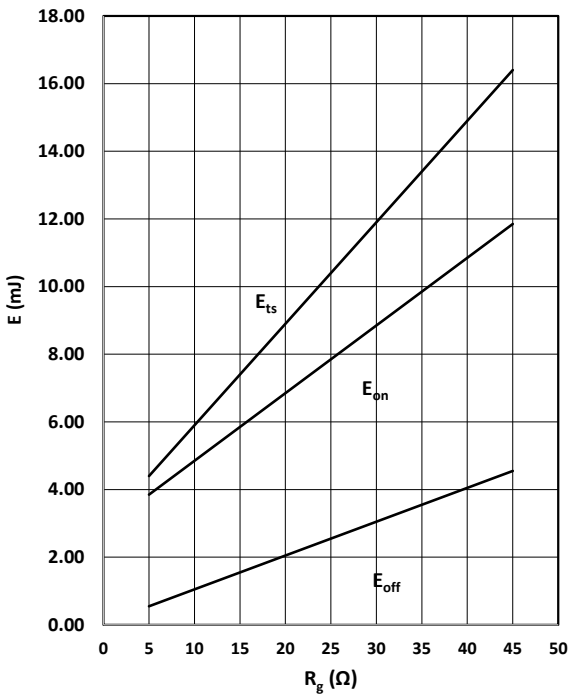
$I_C = f(V_{CE})$; Tj= 25 ℃ vs 150 ℃

Figure 9: IGBT switching energy losses



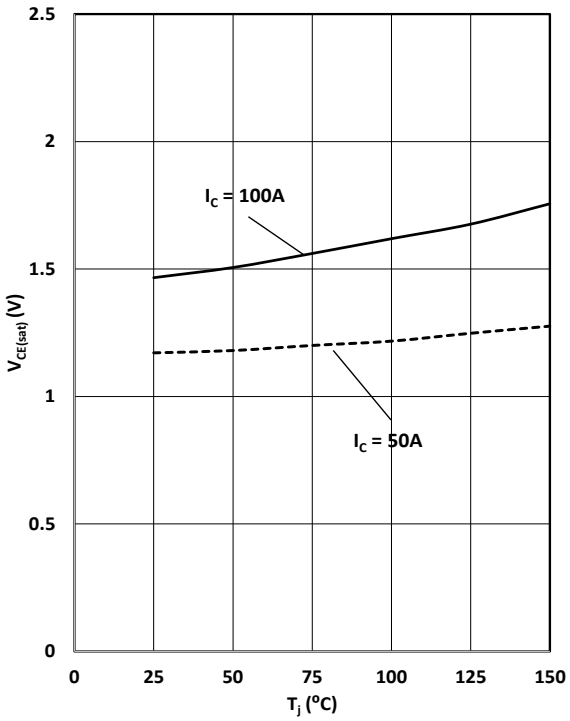
E=f(Ic); V_{CE}=400V; Tj=25 ℃; R_G=15Ω

Figure10: IGBT switching energy losses



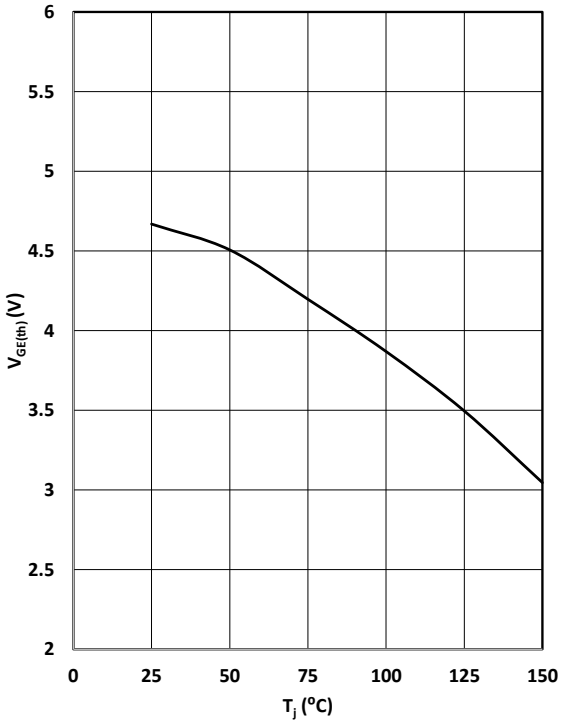
E=f(R_G); V_{CE}=400V; Tj=25 ℃; Ic=100A

Figure 11: Typ. Collector Voltage vs. Temperature



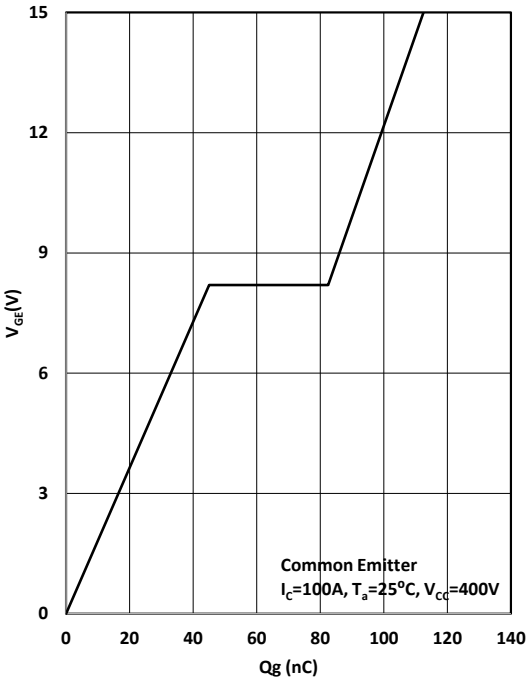
V_{CE} =f(T_j); V_{GE}=15V

Figure 12: Typ. emitter threshold voltage as a function of junction temperature



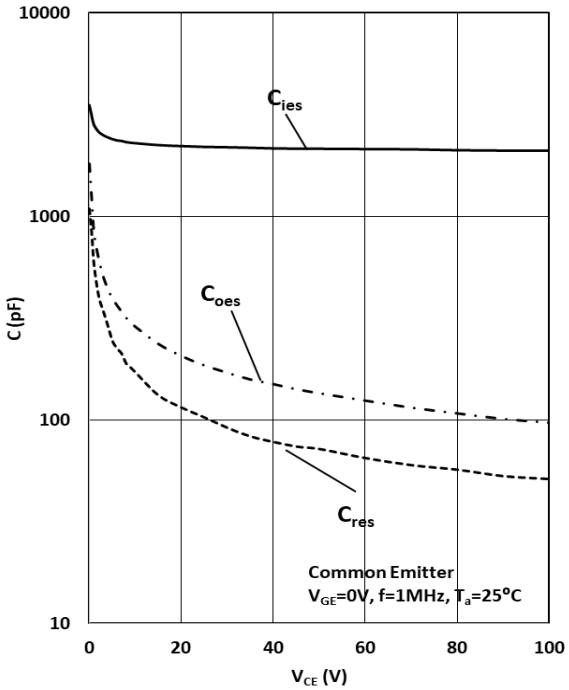
V_{GE} =f(T_j); I_{CE} = 250μA

Figure 13: Typ. Gate Charge



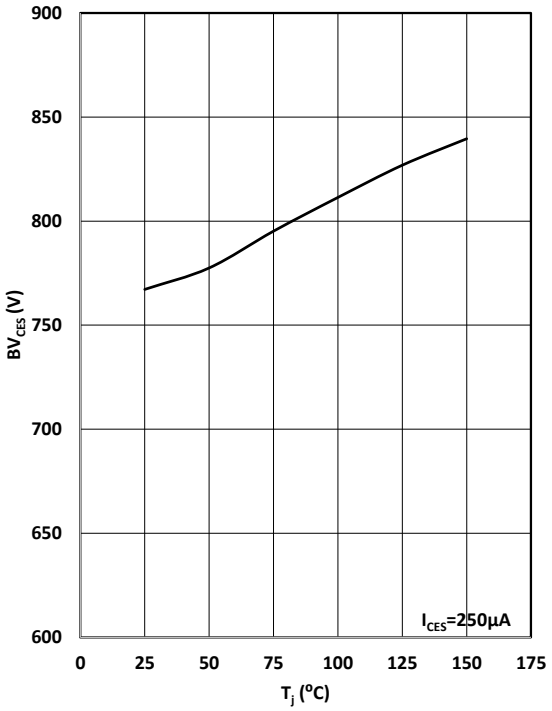
V_{GE}= f(Q_{gate}); I_C= 100A

Figure 14: Typ. Capacitances



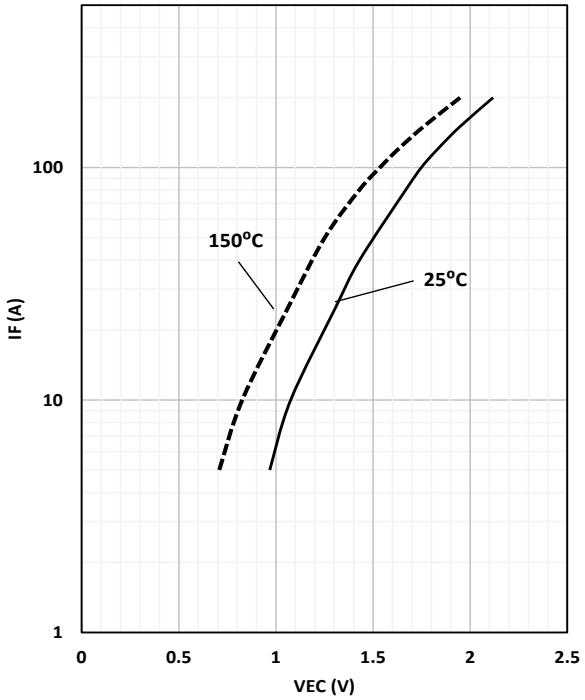
V_{GE}= f(V_{CE}); V_{GE}=0; f=1MHz

Figure 15: Collector-emitter Breakdown Voltage vs. temperature



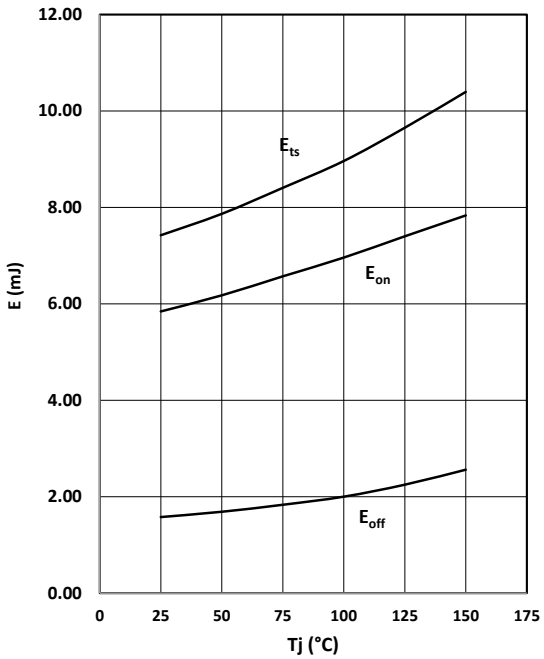
BVces= f(Tj);

Figure 16: Typ. diode forward current as a function of forward voltage



I_F= f(V_{EC});

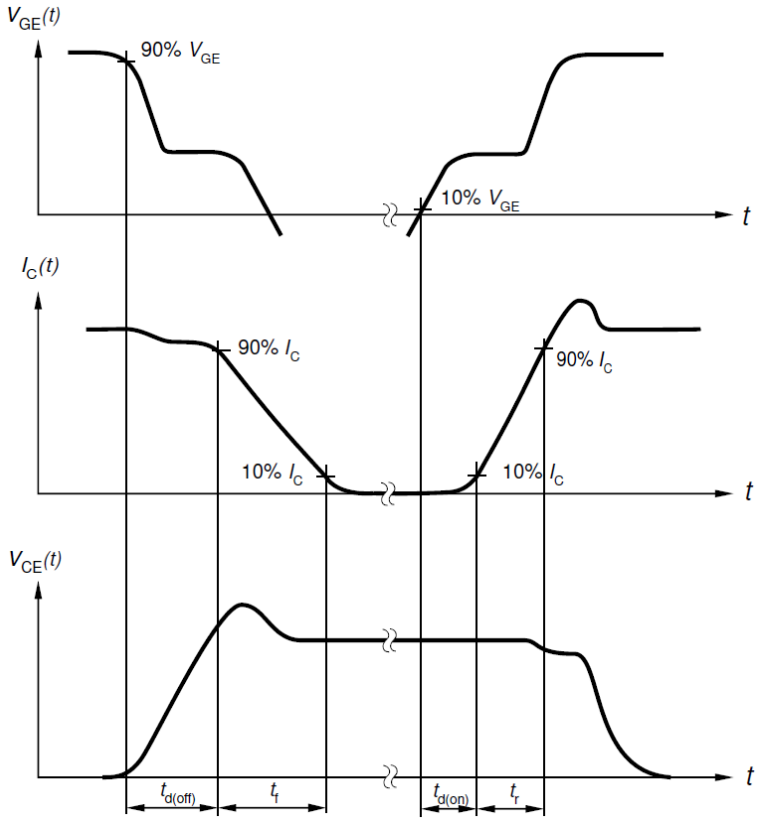
Figure 17: IGBT switching energy losses



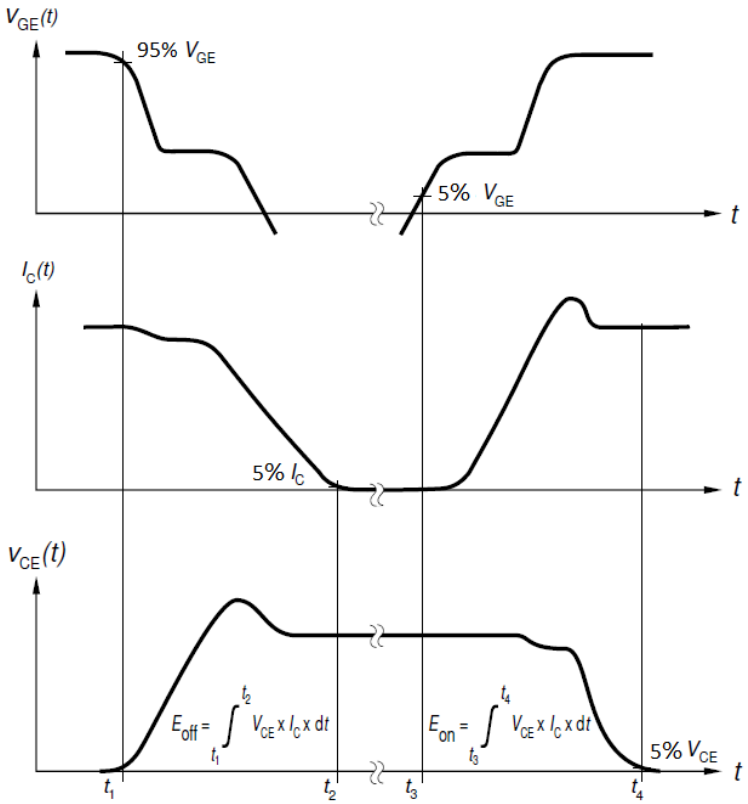
E=f(Tj); V_{CE}=400V; Ic=100A; R_G=15Ω

Test Circuits

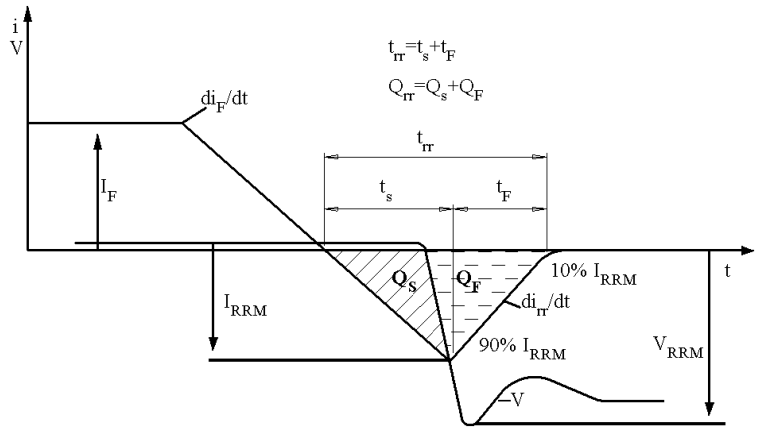
1. Definition Switching times



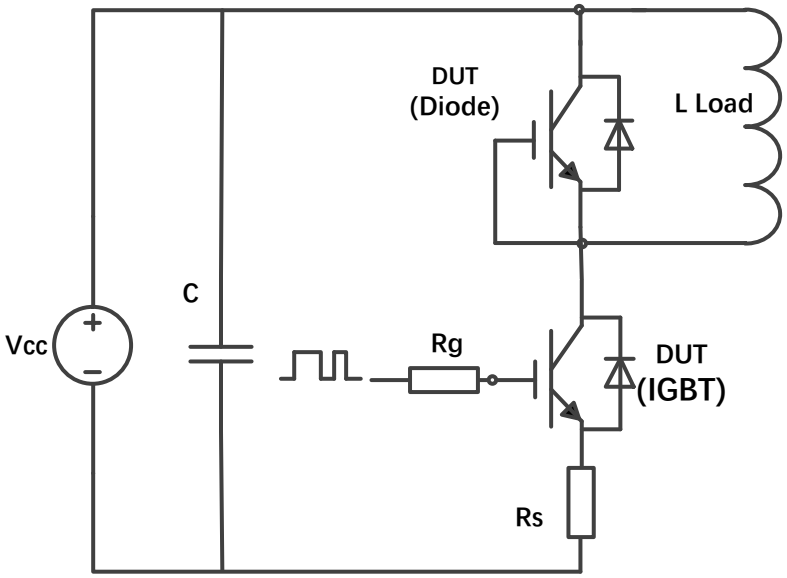
2. Definition Switching losses



3. Definition Diode Switching Characteristics



4. Dynamic Test Circuit



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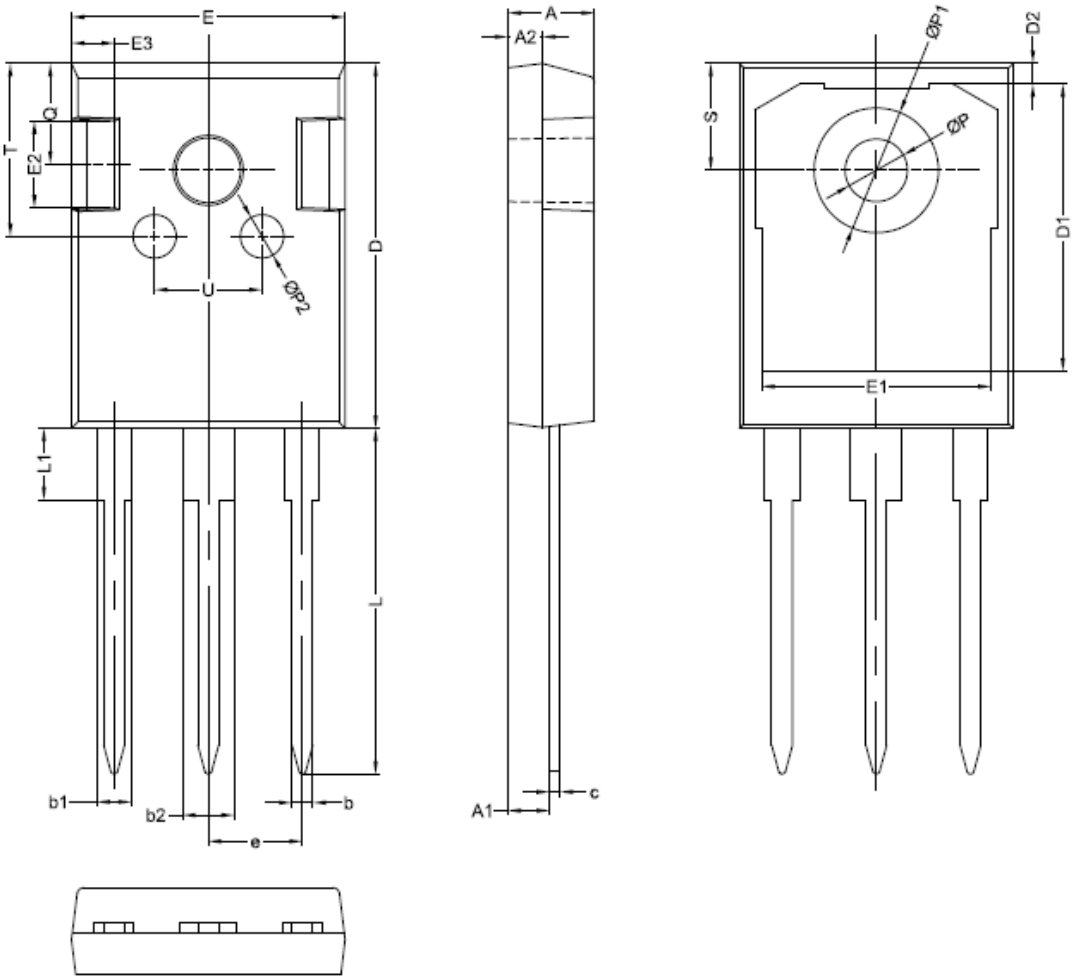
Mechanical Dimensions

TO-247 **Unit: mm**



Symbol	Dimensions(mm)			Symbol	Dimensions(mm)		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.80	5.00	5.20	E2	-	5.00	-
A1	2.21	2.41	2.61	E3	-	2.50	-
A2	1.90	2.00	2.10	e	5.44(BSC)		
b	1.10	1.20	1.35	L	19.42	19.92	20.42
b1	-	2.00	-	L1	-	4.13	-
b2	-	3.00	-	P	3.50	3.60	3.70
c	0.55	0.60	0.75	P1	-	-	7.40
D	20.80	21.00	21.20	P2	-	2.50	-
D1	-	16.55	-	Q	-	5.80	-
D2	-	1.20	-	S	6.05	6.15	6.25
E	15.60	15.80	16.00	T	-	10.00	-
E1	-	13.30	-	U	-	6.20	-

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Sanrise Technology Limited Company

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